

## AZ 1500 Series

Standard  
Photoresists

### GENERAL INFORMATION

This series of positive photoresists actually consists of three different products. They all contain the same photoactive compound (PAC) which responds to the whole UV-spectrum from 310 - 440 nm covering the three main mercury lines, i, h and g. They may be used with broadband as well as monochromatic exposure. Different novolak resins or fractions thereof were chosen to adopt them for different demands, this is indicated by a corresponding suffix of the product designation:

AZ 1500 (no suffix) is the most popular family. This resists may be used for wet- and dry-etch and cover all demands for general semiconductor manufacturing and other applications with resolution down to 1  $\mu\text{m}$ .

AZ 1514 H is intended for contact and proximity printing. For this application a low photospeed for better control of exposure (about 10s at 15 mW/cm<sup>2</sup>) and thus a forgiving resist is the best choice.

AZ 1500 HS family was developed in 1990. The background for this development was the fact that in making discrete and bipolar semiconductor devices wet-etching is still very common. For wet-etching adhesion is the most important issue. Especially on aluminium the mousebite-phenomenon is well known. To solve this problem we have chosen a low molecular weight novolak resin fraction resulting in significantly improved adhesion and also very high photospeed (therefore the suffix **High Speed**). Meanwhile AZ 1500 HS has proven its superior performance in several production lines and lead to less rework and higher yields.

All AZ 1500-series resists are compatible with all common developers used for positive photoresists, like AZ 340 (diluted 1:5), 0.5% NaOH solution and metal ion free developers like AZ 726 MIF. While AZ 1500-family and AZ 1514H are optimised for best process latitude at 50 - 60 seconds development time, AZ 1500HS-family performs best at 20 - 30 seconds development time resulting in a high throughput lithographic process.

# Technical data sheet

## Technisches Datenblatt

### PHYSICAL and CHEMICAL PROPERTIES

AZ	1505	1518	1529	1514H	1512HS	1518HS
Solids content [%]	17.7	29.9	34.0	27.8	26.5	30.4
Viscosity [cSt at 25°C]	6.3	34.2	80.0	24.2	18.0	33.0
Absorptivity [l/g*cm] at 398nm	0.80	1.30	1.36	1.22	1.32	1.50
Solvent	methoxy-propyl acetate (PGMEA)					
Max. water content [%]	0.50					
Spectral sensitivity	310 - 440 nm					
Coating characteristic	striation free					
Filtration [µm absolute]	0.1	0.2	0.1			

### FILM THICKNESS [µm] as FUNCTION of SPIN SPEED (characteristically)

spin speed [rpm]	2000	3000	4000	5000	6000
AZ 1505	0.71	0.58	<b>0.50</b>	0.45	0.41
AZ 1512HS	1.70	1.39	<b>1.20</b>	1.07	0.98
AZ 1514H	1.98	1.62	<b>1.40</b>	1.25	1.14
AZ 1518 and AZ 1518HS	2.55	2.08	<b>1.80</b>	1.61	1.47
AZ 1529	4.10	3.35	<b>2.90</b>	2.59	2.37

### PROCESSING GUIDELINES

Dilution and edge bead removal	AZ EBR Solvent
Prebake	100°C, 50", hotplate
Exposure	broadband and monochromatic
PEB	not required, optional with monochromatic exposure
Development	AZ 340, 1:5 (tank, spray) or AZ 726 (puddle)
Postbake	115°C, 50s hotplate or 30 min. oven
Removal	AZ 100 Remover, conc.

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### HANDLING ADVISES

Consult the **Material Safety Data Sheets** provided by us or your local agent!

This AZ Photoresists are made up with our patented safer solvent PGMEA. They are **flammable liquids** and should be kept away from oxidants, sparks and open flames.

**Protect from light and heat and store** in sealed original containers between 0°C and 25°C, exceeding this range to +27°C for 10 hours, +32°C for 6 hours or +35°C for 5 hours does not adversely affect the properties.

**Shelf life** is 1 year at recommended storage conditions. The **expiration date** is printed on the label of every bottle.

AZ Photoresists are compatible with most commercially available wafer processing equipment. **Recommended materials** include PTFE, stainless steel and high-density polyethylene and -propylene.

We advise our customers regarding technical applications to the best of our knowledge within the scope of the possibilities open to us, but without obligation. Current laws and regulations must be observed at all times. This also applies in respect of any protected rights of third parties. Our suggestions do not relieve our customers of the necessity to test our products, on their own responsibility, for suitability for the purpose envisaged. Quotations from our literature are only permitted with our written authority, and the source must be stated.

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